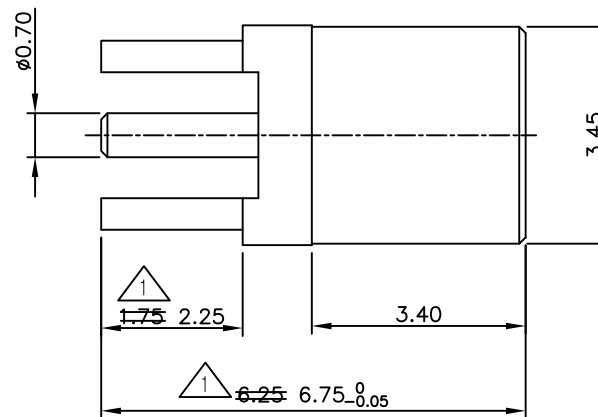
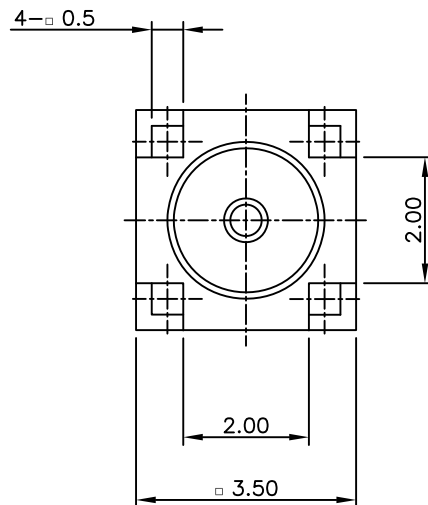


A

B

C

D



REVISION

REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration			2001. 06. 27.
1	[설번처리No.200808-0007] 업체요청 (PCB 리드 길이 변경 1.75->2.25)	E.H.KIM	S.J.YOUN	2008. 08. 27.
2	조립성 개선으로 인한 절연체 억지끼움 -> 뉘시바늘 구조 변경	S.Y.EUN	S.H.KIM	2022. 06. 21.

2	3	INSULATOR	1	TEFLON	White	DIN02282-N/1
1	2	CONTACT	1	BeCu	Gold Plate	DCT01660-5/1 DCT00007-5/1
2	1	BODY	1	MBsBD	Gold Plate	DBD02135-5/1 DBD00020-5/1
	NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE			 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017	
	±0.2	2022. 06. 21.				
Angle		APPROVED BY	S.H.KIM			
	±1°	CHECKED BY				
MATERIAL		DRAWN BY	S.Y.EUN			
-		TITLE				
		MMCX50 PCB J-4R				
FINISH		SCALE	UNIT		A4	
	-	8/1	mm			
				DWG NO.	CN00015-7/2	
				REVISION	2	
				SHEET	1 of 1	

A

B

C

D